Multiphysical Uimulation of T oved Oata Oable M. ÁRaum Friedrich-Alexander Universität, Erlangen, BY, Germany

Introduction: The question for this simulations how the electric and magnetic was, characteristics of an data cable change through the mechanical deformations in case of moved application. An overly simplified model was created to explore some basic changes going on.

Results: The bending of the cable, increased the distance between the conductors, independent of the bending direction. Therefore the inductance and capacitance changed in the way the distributed resistance decreased over the load.



Figure 1. simplified model of the data cable

Computational Methods: To solve for the desired electric and magnetic values, both the static electronic module (es) an the electric an magnetic fields module (mef) were used.







Combined the structural with mechanics module dependencies the between mechanical deformation and electro-magnetic changes were discovered. The main aim was capacitance simulate the the and to inductance.

$$C' = \frac{C}{l} = \frac{\varepsilon_0 \varepsilon_r \pi}{\ln(\frac{2D}{d})} \qquad \qquad L' = \frac{L}{l} = \frac{\mu}{\pi} \ln\left(\frac{D}{d}\right)$$



Figure 5. Distributed resistance over load

Conclusions: As expected the conducting properties of an data cable worsen over the load. Especially in high frequency applications this effects could have an important impact.



References:



- Frank Gustrau, Hochfrquenztechnik, Carl Hanser Verlag (2013)
- Manfred Albach, Elektrotechnik, Pearson 2.

Deutschland GmbH (2011)

Figure 2. Bending with boundary load

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